Review Session for ECE 340 Midterm 2 Question Deck

Bilal Arshad and Brendan Eng

Drift/Diffusion

- What is the physical significance of the Continuity Equation? How could we model carrier concentration changes with nonradiative recombination processes with it (SHR, Auger, trap-assisted)?
- Why is there a negative sign for the hole diffusion current but not one for electrons?
- What is the physical significance of the diffusion length? Why does it depend on minority carrier lifetime rather than majority carrier lifetime?
- Draw the majority carrier drift currents along a PN junction in the neutral regions and depletion regions under forward bias. Repeat under low reverse bias conditions.

Current Injection

- What limiting assumption is made in order to assume that majority/minority carrier currents don't change in the depletion region?
- As a process engineer, you can either adjust the drive times of only either phosphosilicate glass or borosilicate glass. In order to triple the injection current of a P⁺N junction working at a set forward bias, how would you adjust the drive times of one of the furnace steps of the doped glasses? (How would you change the phosphorus or boron doping?)
- What is the physical significance of majority carrier drift current in the neutral regions under forward bias? What does this flux supply?
- Why is it nonphysical to assume that built-in fields and contact potentials only exist in the depletion region? (Multiple reasons)
- Physically, what is occurring in minority carrier extraction? (What is happening to each carrier?)
- Draw carrier distribution profiles under different bias conditions. If the P side is more heavily doped than the N side, how does this affect the magnitude of the carrier concentrations right outside the depletion region and then in the neutral regions?

N⁺N Junction

- Draw the charge density profile
- Draw the electric field profile
- Draw the voltage profile
- Fundamentally, how is the mechanism of carrier movement different than a PN junction?
- Draw a qualitative band diagram. Assuming Boltzmann approximation is a fine substitute for Fermi-Dirac Statistics, show the limitations in how you draw the Fermi levels.

Graded Junction

An NP junction follows a linear grading doping profile from N_D in the N region to N_A in the P region. Assume the linear grading positions fall exactly within the bounds of the depletion region and that the point of minimal background doping occurs at the metallurgical junction

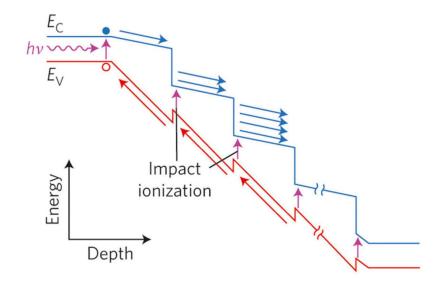
- Draw the charge density profile
- Draw the electric field profile
- Draw the voltage profile
- To follow this doping profile, how do the Fermi levels vary within each side of the junction?

Capacitance

- In what regime for voltage conditions would junction capacitance dominate over diffusion capacitance and vice versa?
- In a one-sided step junction, which doping level can be measured and why? Derive how this would be done
- Derive diffusion capacitance using charge storage model
- Why are capacitive effects harmful for high-speed devices?

Breakdown

- If we increase the temperature of a PN junction under moderate reverse bias, what will happen to the magnitudes of the breakdown voltages for Avalanche Breakdown and Zener Breakdown?
- At moderate reverse bias conditions under relatively low doping, how should the breakdown behavior change as doping is increased?
- On the right is an image of a Staircase APD; how is the Avalanche behavior enhanced with this design? How would this affect the magnitude of the breakdown voltage?
- For low noise APDs, the ionization coefficient of one carrier (electron or holes) is designed to be significantly higher than the other. How does this change a schematic of how impact ionization is depicted in Avalance breakdown?



Ren, Min et al. "AllnAsSb/GaSb Staircase Avalanche Photodiode". Applied Physics Letters 108.8 (2016):

Photodiodes

- What are the design constraints for the intrinsic region within a P-I-N diode used for a photodetector?
- What is the maximum value of gain for a photodiode? What testing parameters or material parameters would you change to exceed this limiting gain coefficient in the aforementioned question?
- How would we select the bandgap for a photodiode in order to improve the signal to noise ratio of a photodiode?
- How could you tune different voltage conditions in order to measure the multiplication factor of an APD just by measuring responsivity values?

Optoelectronics

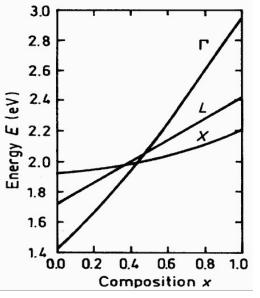
- What are the three processes that describe generation and recombination for electrons and holes for a laser? Show the expressions for these rates as a function of carrier concentration, optical field density, and Einstein Coefficients
- For a PN junction photodiode, show the corresponding IV curves respectively for $h\nu>$ E $_{\rm g}$ and $h\nu<$ E $_{\rm g}$ for g $_{\rm 3}>$ g $_{\rm 2}>$ g $_{\rm 1}>$ g $_{\rm 0}=$ 0 (A total of 8 curves)
- What's the advantage of quaternary alloys over ternary alloys for optoelectronic design and processing?
- Why are GaP and AlAs not used for blue light-emitting applications over GaN especially when GaP and AlAs occur more abundantly as zincblende crystals over wurtzite?
- Who discovered III-V oxidation (a technique used to form the insulating layers of VCSELs)?
- Who was John Dallesasse's advisor?

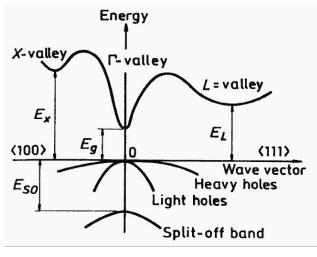
Optoelectronics

- Say we have a GaAs PN junction with ohmic contacts on both sides. If we shine light on the solar cell, how come there is a split in the quasifermi levels even when no external voltage was applied to the device? What is this effect called, and what is the maximum voltage that can be generated from this effect?
- How come EHPs generated due to photon excitation can occur in a width greater than the depletion region?
- What are the tradeoffs in doping too high or too low for efficient carrier collection for a solar cell?

Optoelectronics

 On the right is an image of the different bandgaps at different symmetry locations of Al_xGa_{1-x}As as a function of concentration. What concentration range can you use Al_xGa_{1-x}As efficiently for light generation? Why can't we tune green and blue wavelengths with this material?





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Schottky Barriers

- Do we have to worry about charge storage effects with Schottky diodes?
 Why or why not?
- Say we want to make a P type Ohmic contact to silicon with a metal with a workfunction of 4.04 eV. What is the threshold doping level above which carriers will start to become depleted from silicon?
- Without using any applied bias, can you form back to back Ohmic contacts using a moderately doped n type silicon interlayer?
- It is common in III-V compounds that surface states can pin the Fermi level to the mid-gap regardless of doping. How would this affect making contacts to a device?
- How does the tunnel barrier from the metal to the semiconductor depend upon doping?

Questions?

Email me (beng3@illinois.edu) for questions about these questions or for more review questions